

## **Description**

This document details the custom configuration that is programmed into the one-time-programmable (OTP) memory of the 9FGV1006C001LTGI. Please refer to the device datasheet for further information about the device.

## **General Configuration**

Parameter	Value	Units
Device I <sup>2</sup> C Address	Primary 0xD0	_
Default Configuration at I <sup>2</sup> C Mode	0	_

## **Frequency Overview**

Parameter	Configuration 0	Configuration 1	Configuration 2	Configuration 3	Units
Input	25	25	25	25	MHz
REF 0	_	_	_	_	_
Output 0	100	100	100	100	MHz
Output 1	100	100	100	100	MHz

### Configuration 0 Parameters: SEL[1:0] = 00

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	_	_	%
Spread Spectrum Modulation	_	_	_	kHz
LP-HCSL Impedance	_	100	100	Ω



## Configuration 1 Parameters: SEL[1:0] = 01

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.1	-0.1	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω

## Configuration 2 Parameters: SEL[1:0] = 10

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.3	-0.3	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω

# Configuration 3 Parameters: SEL[1:0] = 11

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	3.3	3.3	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.5	-0.5	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω



# **Package Outline Drawings and Marking Diagrams**

Refer to the datasheet for detailed information pertaining to package outline drawings and marking diagrams.

## **Ordering Information**

Orderable Part Number	Carrier Type	Temperature	Crystal
9FGV1006C001LTGI	Tray	-40° to +85°C	External
9FGV1006C001LTGI8	Tape and Reel	-40° to +85°C	External

# **Revision History**

Revision Date	Description of Change
September 17, 2020	Initial release.

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